

## P-Ch 60V Fast Switching MOSFETs

### Features:

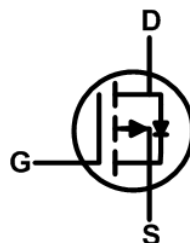
- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent  $CdV/dt$  effect decline
- ★ Advanced high cell density Trench technology



TO252 Pin Configuration

### Description:

The KJD6107 is the high cell density trenched P-ch MOSFETs, which provide excellent  $R_{DS(on)}$  and gate charge for most of the synchronous buck converter applications. The KJD6107 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.



### Product Summary

| BVDSS | $R_{DS(on)}$ | ID  |
|-------|--------------|-----|
| -60V  | 180mΩ        | -8A |

### Absolute Maximum Ratings

| Symbol                | Parameter                                              | Rating     | Units      |
|-----------------------|--------------------------------------------------------|------------|------------|
| $V_{DS}$              | Drain-Source Voltage                                   | -60        | V          |
| $V_{GS}$              | Gate-Source Voltage                                    | $\pm 20$   | V          |
| $I_D@T_C=25^\circ C$  | Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup> | -8         | A          |
| $I_D@T_C=100^\circ C$ | Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup> | -5.1       | A          |
| $I_D@T_A=25^\circ C$  | Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup> | -2.5       | A          |
| $I_D@T_A=70^\circ C$  | Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup> | -2         | A          |
| $I_{DM}$              | Pulsed Drain Current <sup>2</sup>                      | -16        | A          |
| EAS                   | Single Pulse Avalanche Energy <sup>3</sup>             | 11.7       | mJ         |
| $I_{AS}$              | Avalanche Current                                      | -15.3      | A          |
| $P_D@T_C=25^\circ C$  | Total Power Dissipation <sup>4</sup>                   | 20.8       | W          |
| $P_D@T_A=25^\circ C$  | Total Power Dissipation <sup>4</sup>                   | 2          | W          |
| $T_{STG}$             | Storage Temperature Range                              | -55 to 150 | $^\circ C$ |
| $T_J$                 | Operating Junction Temperature Range                   | -55 to 150 | $^\circ C$ |

### Thermal Data

| Symbol          | Parameter                                        | Typ. | Max. | Unit         |
|-----------------|--------------------------------------------------|------|------|--------------|
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient <sup>1</sup> | ---  | 62   | $^\circ C/W$ |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case <sup>1</sup>    | ---  | 6    | $^\circ C/W$ |

**Electrical Characteristics ( $T_J=25\text{ }^{\circ}\text{C}$ , unless otherwise noted)**

| Symbol                       | Parameter                                      | Conditions                                            | Min. | Typ.   | Max.      | Unit                         |
|------------------------------|------------------------------------------------|-------------------------------------------------------|------|--------|-----------|------------------------------|
| $BV_{DSS}$                   | Drain-Source Breakdown Voltage                 | $V_{GS}=0V, I_D=-250\mu A$                            | -60  | ---    | ---       | V                            |
| $\Delta BV_{DSS}/\Delta T_J$ | $BV_{DSS}$ Temperature Coefficient             | Reference to $25^{\circ}\text{C}$ , $I_D=-1\text{mA}$ | ---  | -0.021 | ---       | $\text{V}/^{\circ}\text{C}$  |
| $R_{DS(ON)}$                 | Static Drain-Source On-Resistance <sup>2</sup> | $V_{GS}=-10V, I_D=-8A$                                | ---  | ---    | 180       | $\text{m}\Omega$             |
|                              |                                                | $V_{GS}=-4.5V, I_D=-4A$                               | ---  | ---    | 266       |                              |
| $V_{GS(th)}$                 | Gate Threshold Voltage                         | $V_{GS}=V_{DS}, I_D=-250\mu A$                        | -1.0 | ---    | -2.5      | V                            |
| $\Delta V_{GS(th)}$          | $V_{GS(th)}$ Temperature Coefficient           |                                                       | ---  | 4.08   | ---       | $\text{mV}/^{\circ}\text{C}$ |
| $I_{DSS}$                    | Drain-Source Leakage Current                   | $V_{DS}=-48V, V_{GS}=0V, T_J=25^{\circ}\text{C}$      | ---  | ---    | 1         | $\mu A$                      |
|                              |                                                | $V_{DS}=-48V, V_{GS}=0V, T_J=55^{\circ}\text{C}$      | ---  | ---    | 5         |                              |
| $I_{GSS}$                    | Gate-Source Leakage Current                    | $V_{GS}=\pm 20V, V_{DS}=0V$                           | ---  | ---    | $\pm 100$ | nA                           |
| $g_{fs}$                     | Forward Transconductance                       | $V_{DS}=-10V, I_D=-8A$                                | ---  | 8.3    | ---       | S                            |
| $Q_g$                        | Total Gate Charge (-4.5V)                      | $V_{DS}=-20V, V_{GS}=-4.5V, I_D=-6A$                  | ---  | 4.6    | ---       | nC                           |
| $Q_{gs}$                     | Gate-Source Charge                             |                                                       | ---  | 1.4    | ---       |                              |
| $Q_{gd}$                     | Gate-Drain Charge                              |                                                       | ---  | 1.62   | ---       |                              |
| $T_{d(on)}$                  | Turn-On Delay Time                             | $V_{DD}=-15V, V_{GS}=-10V, R_G=3.3\Omega, I_D=-1A$    | ---  | 17.4   | ---       | ns                           |
| $T_r$                        | Rise Time                                      |                                                       | ---  | 5.4    | ---       |                              |
| $T_{d(off)}$                 | Turn-Off Delay Time                            |                                                       | ---  | 37.2   | ---       |                              |
| $T_f$                        | Fall Time                                      |                                                       | ---  | 2.4    | ---       |                              |
| $C_{iss}$                    | Input Capacitance                              | $V_{DS}=-15V, V_{GS}=0V, f=1\text{MHz}$               | ---  | 531    | ---       | pF                           |
| $C_{oss}$                    | Output Capacitance                             |                                                       | ---  | 59     | ---       |                              |
| $C_{rss}$                    | Reverse Transfer Capacitance                   |                                                       | ---  | 38     | ---       |                              |

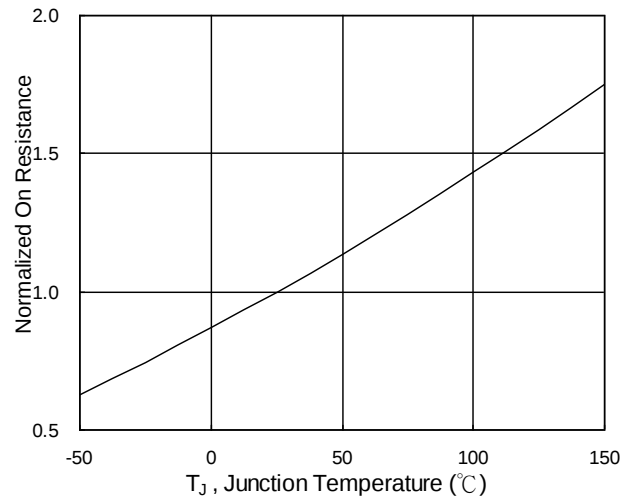
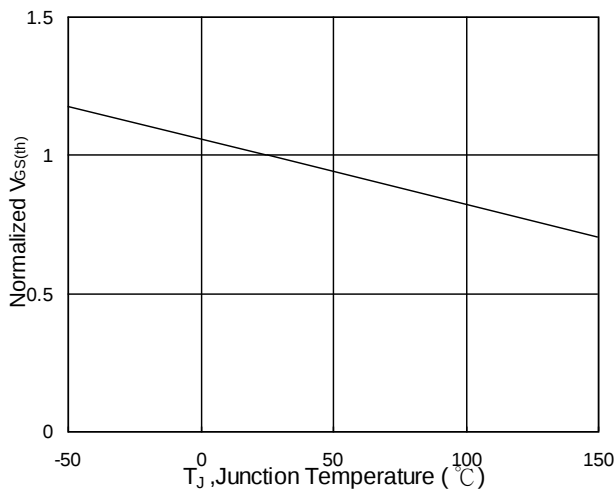
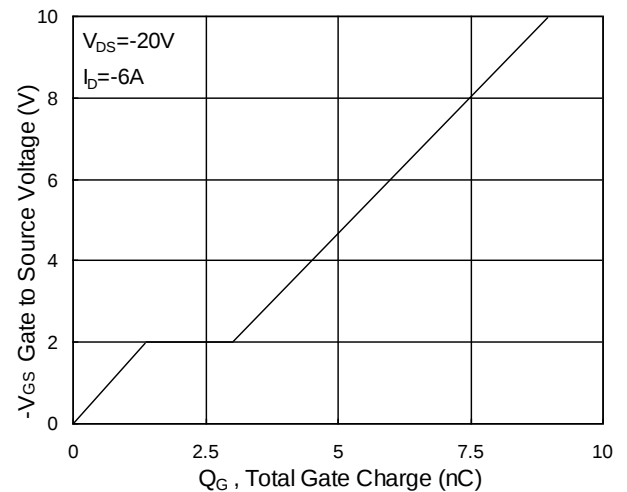
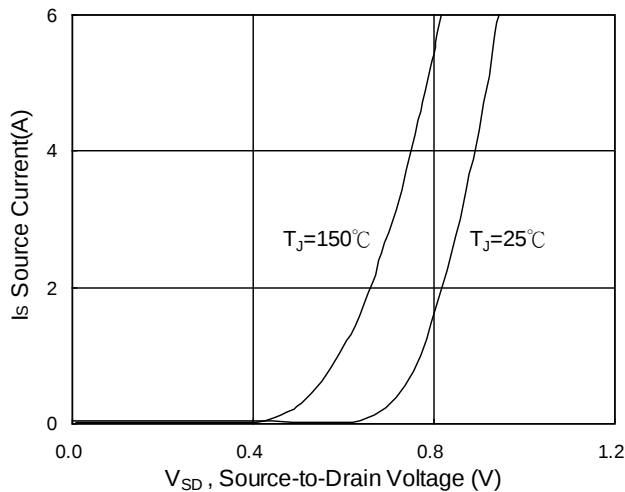
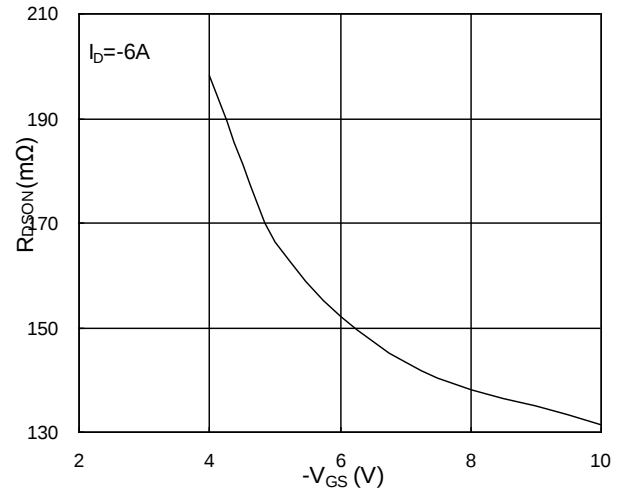
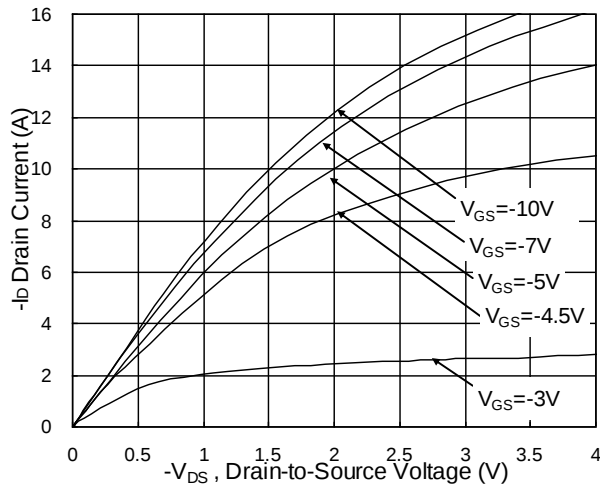
**Diode Characteristics**

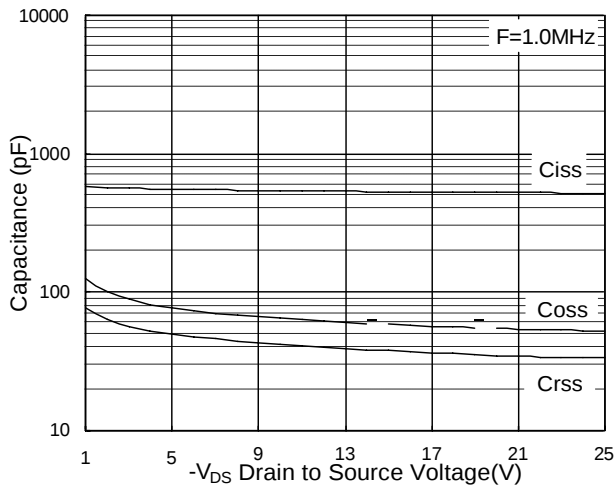
| Symbol   | Parameter                                | Conditions                                   | Min. | Typ. | Max. | Unit |
|----------|------------------------------------------|----------------------------------------------|------|------|------|------|
| $I_S$    | Continuous Source Current <sup>1,5</sup> | $V_G=V_D=0V$ , Force Current                 | ---  | ---  | -8   | A    |
| $I_{SM}$ | Pulsed Source Current <sup>2,5</sup>     |                                              | ---  | ---  | -16  | A    |
| $V_{SD}$ | Diode Forward Voltage <sup>2</sup>       | $V_{GS}=0V, I_S=-1A, T_J=25^{\circ}\text{C}$ | ---  | ---  | -1.2 | V    |

Note :

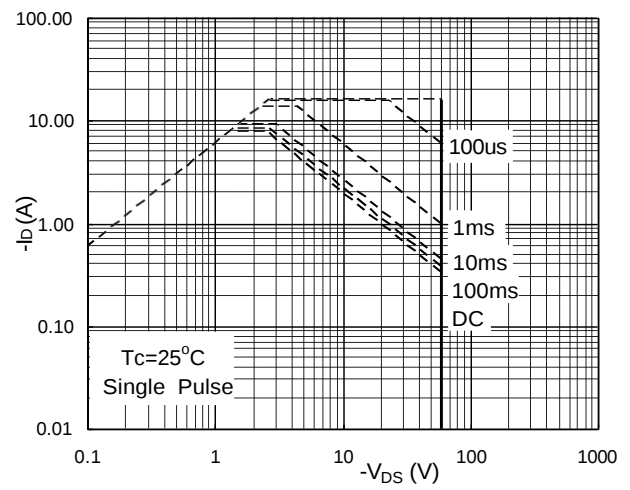
- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 20Z copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is  $V_{DD}=-25V, V_{GS}=-10V, L=0.1\text{mH}, I_{AS}=-15.3A$
- 4.The power dissipation is limited by  $150^{\circ}\text{C}$  junction temperature
- 5.The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications , should be limited by total power dissipation.

## Typical Characteristics

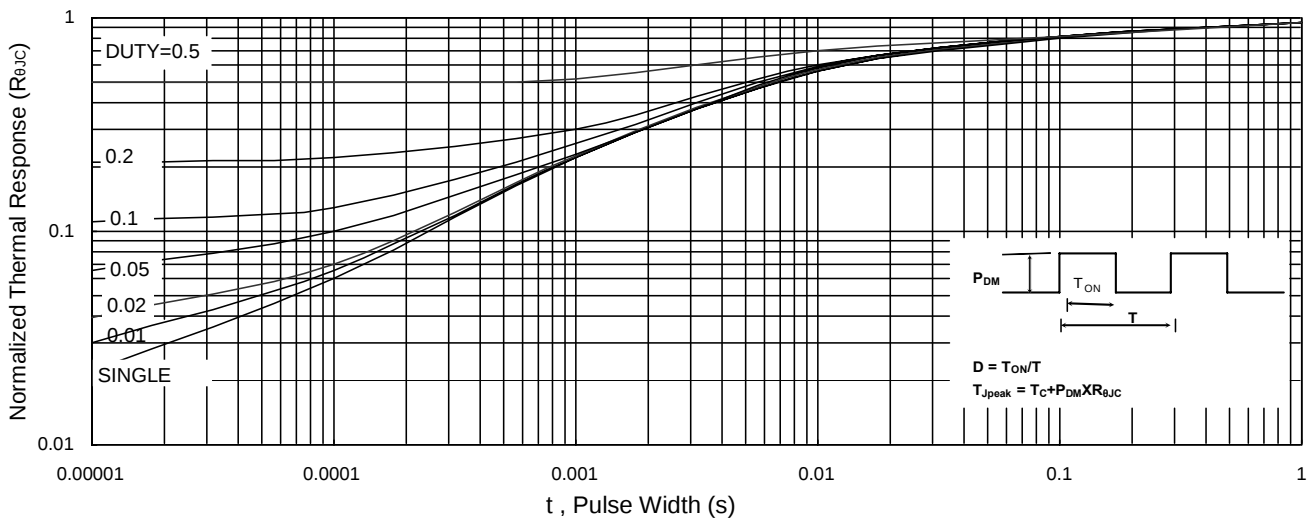




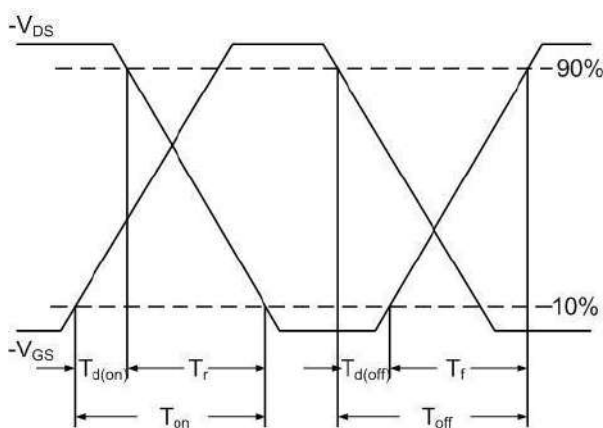
**Fig.7 Capacitance**



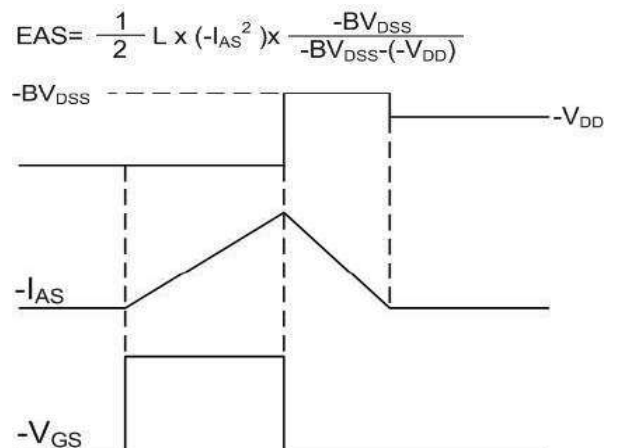
**Fig.8 Safe Operating Area**



**Fig.9 Normalized Maximum Transient Thermal Impedance**



**Fig.10 Switching Time Waveform**



**Fig.11 Unclamped Inductive Switching Waveform**